650V, 45A, V<sub>CE(on)</sub>= 1.9V Typical

## Ultra Fast NPT - IGBT<sup>®</sup> with Ultra Soft Recovery Diode

The Ultra Fast 650V NPT-IGBT<sup>®</sup> family of products is the newest generation of IGBTs optimized for outstanding ruggedness and best trade-off between conduction and switching losses.

## Features

- Low Saturation Voltage
- Low Tail Current
- RoHS Compliant 🥒
- Smooth Reverse Recovery
- Short Circuit Withstand Rated
- High Frequency Switching
- Ultra Low Leakage Current
- Snap-free Switching

Unless stated otherwise, Microsemi discrete IGBTs contain a single IGBT die. This device is recommended for applications such as induction heating (IH), motor control, general purpose inverters and uninterruptible power supplies (UPS).

## MAXIMUM RATINGS

All Ratings:	$T_{C} = 25^{\circ}C$	unless	otherwise	specified.

Symbol	Parameter	Ratings	Unit
V <sub>CES</sub>	Collector Emitter Voltage	650	V
V <sub>GE</sub>	Gate-Emitter Voltage	±30	V
I <sub>C1</sub>	Continuous Collector Current @ T <sub>c</sub> = 25°C	118	
I <sub>C2</sub>	Continuous Collector Current @ T <sub>c</sub> = 110°C	56	А
I <sub>CM</sub>	Pulsed Collector Current ①	224	
SCWT	Short Circuit Withstand Time: $V_{ce}$ = 325V, $V_{ge}$ = 15V, $T_c$ =125°C	10	μs
P <sub>D</sub>	Total Power Dissipation @ $T_c = 25^{\circ}C$	543	W
T_,T <sub>stg</sub>	Operating and Storage Junction Temperature Range	-55 to 150	°C
TL	Max. Lead Temp. for Soldering: 0.063" from Case for 10 Sec.	300	C

## STATIC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Min	Тур	Max	Unit
V <sub>(BR)CES</sub>	Collector-Emitter Breakdown Voltage ( $V_{GE} = 0V$ , $I_{C} = 350\mu$ A)	650			
V <sub>GE(TH)</sub>	Gate Threshold Voltage $(V_{CE} = V_{GE}, I_{C} = 2.5 \text{mA}, T_{j} = 25^{\circ}\text{C})$	3.5	5.0	6.5	
	Collector-Emitter On Voltage ( $V_{GE}$ = 15V, $I_{c}$ = 45A, $T_{j}$ = 25°C)		1.9	2.4	Volts
V <sub>CE(ON)</sub>	Collector-Emitter On Voltage ( $V_{GE}$ = 15V, $I_{c}$ = 45A, $T_{j}$ = 125°C)		2.4		
()	Collector-Emitter On Voltage ( $V_{GE}$ = 15V, $I_{c}$ = 90A, $T_{j}$ = 25°C)		2.6		
	Collector Cut-off Current (V <sub>CE</sub> = 650V, V <sub>GE</sub> = 0V, T <sub>j</sub> = 25°C) <sup>(2)</sup>		20	350	
I <sub>CES</sub>	Collector Cut-off Current (V <sub>CE</sub> = 650V, V <sub>GE</sub> = 0V, T <sub>j</sub> = 125°C) <sup>(2)</sup>		200		μA
I <sub>GES</sub>	Gate-Emitter Leakage Current (V <sub>GE</sub> = ±20V)			±250	nA

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.









#### **DYNAMIC CHARACTERISTICS**

#### APT45GR65B2DU30

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
C <sub>ies</sub>	Input Capacitance	Capacitance		2900		
C <sub>oes</sub>	Output Capacitance	$V_{GE} = 0V, V_{CE} = 25V$		548		pF
C <sub>res</sub>	Reverse Transfer Capacitance	f = 1MHz		268		I.
V <sub>GEP</sub>	Gate to Emitter Plateau Voltage	Gate Charge	1	7.5		V
Q <sub>q</sub> 3	Total Gate Charge	 V <sub>GF</sub> = 15V		150	203	
Q <sub>ge</sub>	Gate-Emitter Charge	V <sub>ce</sub> = 325V		18	24	nC
Q <sub>gc</sub>	Gate- Collector Charge	– I <sub>c</sub> = 45A		74	100	
t <sub>d(on)</sub>	Turn-On Delay Time	Inductive Switching (25°C)	1	15		
t,	Current Rise Time	V <sub>cc</sub> = 433V		32		
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>GF</sub> = 15V		100		ns
t,	Current Fall Time	I <sub>c</sub> = 45A		50		
E <sub>on2</sub> 5	Turn-On Switching Energy	$R_{G} = 4.3\Omega^{4}$		1100	1650	
E <sub>off</sub>	Turn-Off Switching Energy	T_ = +25°C		540	870	μJ
t <sub>d(on)</sub>	Turn-On Delay Time	Inductive Switching (125°C)	1	15		
t <sub>r</sub>	Current Rise Time	V <sub>cc</sub> = 433V		32		
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>GE</sub> = 15V		123		ns
t <sub>r</sub>	Current Fall Time	I <sub>c</sub> = 45A		52		
E <sub>on2</sub> 5	Turn-On Switching Energy	$R_{g} = 4.3\Omega^{4}$		1600	2400	1
E <sub>off</sub>	Turn-Off Switching Energy	T <sub>1</sub> = +125°C		800	1160	μJ

#### THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Characteristic	Min	Тур	Max	Unit
R <sub>ejc</sub>	Junction to Case Thermal Resistance (IGBT)			0.23	°C/W
	Junction to Case Thermal Resistance (Diode)			0.80	
R <sub>eja</sub>	Junction to Ambient Thermal Resistance			40	
	Dockage Weight		0.22		oz
W <sub>T</sub>	Package Weight		6.2		g

1 Repetitive Rating: Pulse width and case temperature limited by maximum junction temperature.

2 Pulse test: Pulse Width <  $380\mu s$ , duty cycle < 2%.

3 See Mil-Std-750 Method 3471.

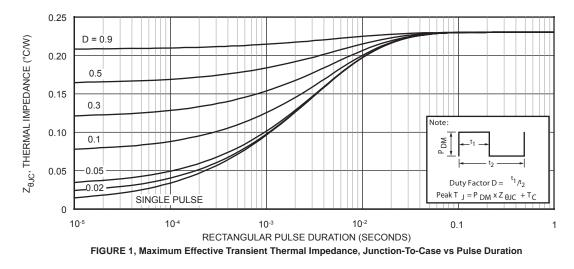
4 R<sub>6</sub> is external gate resistance, not including internal gate resistance or gate driver impedance. (MIC4452)

5 E<sub>on2</sub> is the energy loss at turn-on and includes the charge stored in the freewheeling diode.

 $6 E_{off}$  is the clamped inductive turn-off energy measured in accordance with JEDEC standard JESD24-1.

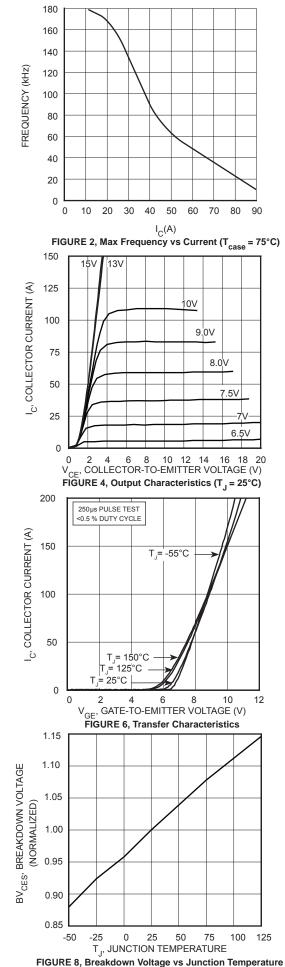
Microsemi reserves the right to change, without notice, the specifications and information contained herein.

### **TYPICAL PERFORMANCE CURVES**



#### **TYPICAL PERFORMANCE CURVES**

#### APT45GR65B2DU30



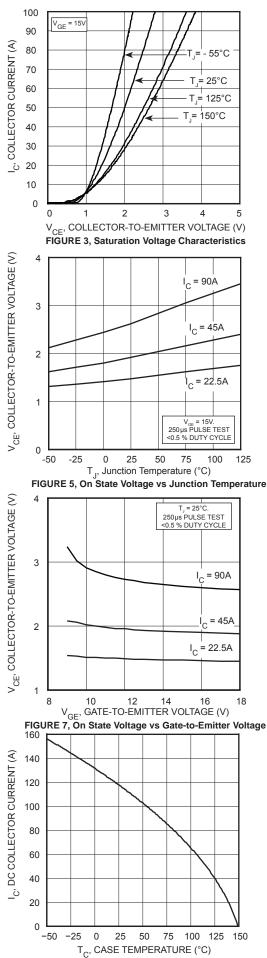
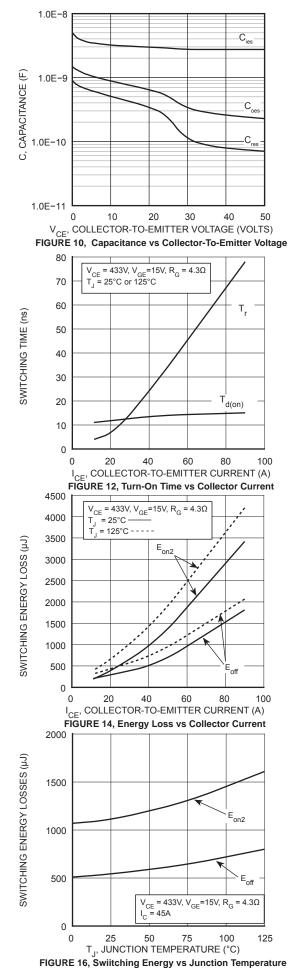


FIGURE 9, DC Collector Current vs Case Temperature

#### **TYPICAL PERFORMANCE CURVES**

#### APT45GR65B2DU30



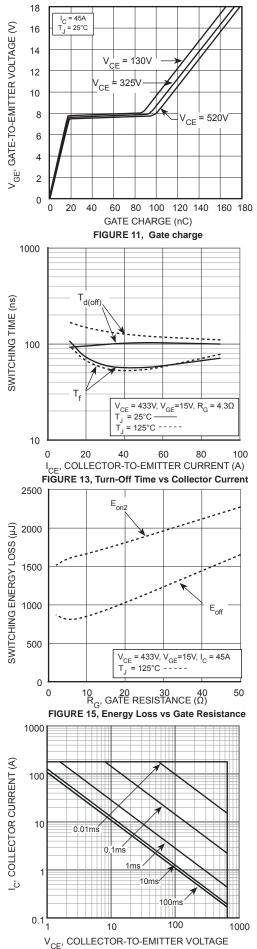


FIGURE 17, Minimum Switching Safe Operating Area

# **ULTRA SOFT RECOVERY ANTI-PARALLEL DIODE**

### **MAXIMUM RATINGS**

All Ratings:  $T_{C}$  = 25°C unless otherwise specified.

Symbol	Characteristic / Test Conditions	APT45GR65B2DU30	Unit
I <sub>F(AV)</sub>	Maximum Average Forward Current ( $T_c = 82^{\circ}C$ , Duty Cycle = 0.5)	30	
I <sub>F(RMS)</sub>	RMS Forward Current (Square wave, 50% duty)	41	Amps
I <sub>FSM</sub>	Non-Repetitive Forward Surge Current (T <sub>J</sub> = 45°C, 8.3ms)	210	

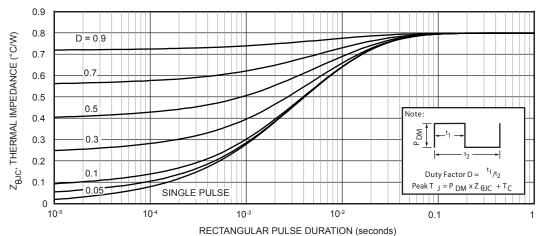
### STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions		Min	Тур	Max	Unit
		I <sub>F</sub> = 30A		3		
V <sub>F</sub>	V <sub>F</sub> Forward Voltage	I <sub>F</sub> = 60A		3.9		Volts
		I <sub>F</sub> = 60A, T <sub>J</sub> = 125°C		3.5		

#### **DYNAMIC CHARACTERISTICS**

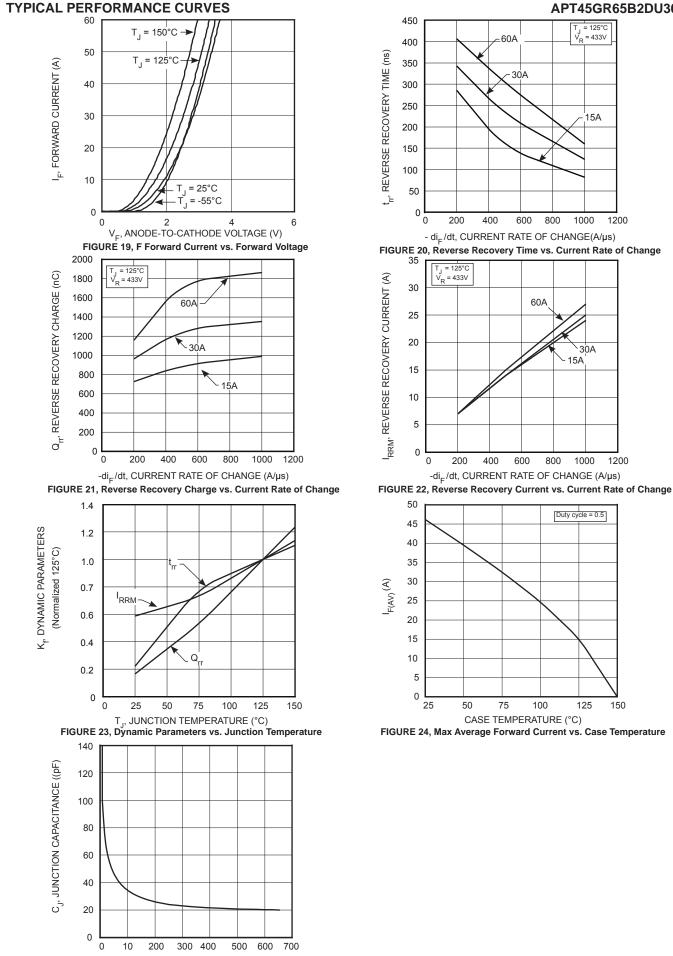
Symbol	Parameter	Test Conditions	Min	Тур	Мах	Unit
t <sub>rr</sub>	Reverse Recovery Time	$I_{_{\rm F}}$ = 1.0A, dif/dt= -100 A/µs, $V_{_{\rm R}}$ = 30V, $T_{_{\rm J}}$ = 25°C		28		ns
t <sub>rr</sub>	Reverse Recovery Time	I <sub>=</sub> = 30 Amps		80		ns
Q <sub>rr</sub>	Reverse Recovery Charge	dif/dt= -200 A/µs		110		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current	V <sub>R</sub> = 433 Volts		3		Amps
E <sub>rr</sub>	Reverse Recovery Energy	T <sub>j</sub> = 25°C		2		μJ
t <sub>rr</sub>	Reverse Recovery	I <sub>=</sub> = 30 Amps		343		ns
Q <sub>rr</sub>	Reverse Recovery Charge	dif/dt= -200 A/µs		965		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current	$V_{R} = 433$ Volts		7		Amps
E <sub>rr</sub>	Reverse Recovery Energy	T <sub>j</sub> = 125°C		88		μJ
t <sub>rr</sub>	Reverse Recovery	I <sub>=</sub> = 30 Amps		124		ns
Q <sub>rr</sub>	Reverse Recovery Charge	dif/dt= -1000 A/µs		1355		nC
I <sub>RRM</sub>	Maximum Reverse Recovery Current	V <sub>R</sub> = 433 Volts T <sub>j</sub> = 125°C		24		Amps
E <sub>rr</sub>	Reverse Recovery Energy			211		μJ
S	Softness Factor $(t_b/t_a)$	$I_{_{\rm F}}$ = 15A, dif/dt= -1000 A/µs, V $_{_{\rm R}}$ = 800V, T $_{_{\rm J}}$ = 125°C		2		

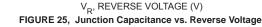
## **TYPICAL PERFORMANCE CURVES**



052-6435 Rev A 6-2014

RECTANGULAR PULSE DURATION (seconds) FIGURE 18, MAXIMUM EFFECTIVE TRANSIENT THERMAL IMPEDANCE, JUNCTION-TO-CASE vs. PULSE DURATION





APT45GR65B2DU30

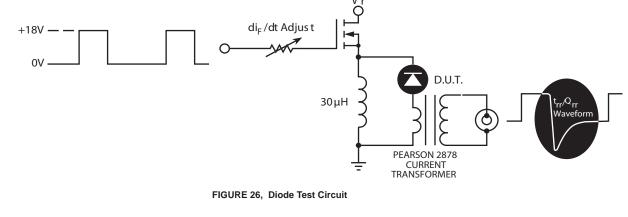
15A

1200

1200

150

#### APT45GR65B2DU30





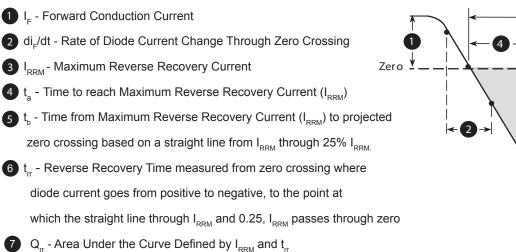
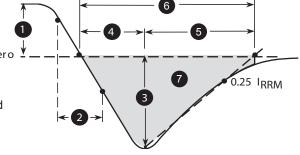
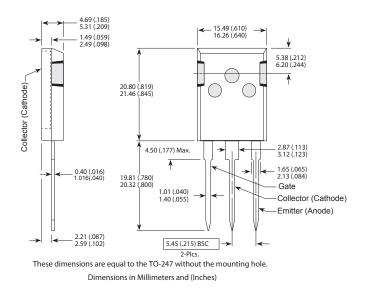


FIGURE 27, Diode Reverse Recovery Waveform Definition



## T-MAX<sup>®</sup> (B2) Package Outline



#### **Disclaimer:**

The information contained in the document (unless it is publicly available on the Web without access restrictions) is PROPRIETARY AND CONFIDENTIAL information of Microsemi and cannot be copied, published, uploaded, posted, transmitted, distributed or disclosed or used without the express duly signed written consent of Microsemi. If the recipient of this document has entered into a disclosure agreement with Microsemi, then the terms of such Agreement will also apply. This document and the information contained herein may not be modified, by any person other than authorized personnel of Microsemi. No license under any patent, copyright, trade secret or other intellectual property right is granted to or conferred upon you by disclosure or delivery of the information, either expressly, by implication, inducement, estoppels or otherwise. Any license under such intellectual property rights must be approved by Microsemi in writing signed by an officer of Microsemi.

Microsemi reserves the right to change the configuration, functionality and performance of its products at anytime without any notice. This product has been subject to limited testing and should not be used in conjunction with life-support or other mission-critical equipment or applications. Microsemi assumes no liability whatsoever, and Microsemi disclaims any express or implied warranty, relating to sale and/or use of Microsemi products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right. Any performance specifications believed to be reliable but are not verified and customer or user must conduct and complete all performance and other testing of this product as well as any user or customer's final application. User or customer shall not rely on any data and performance specifications or parameters provided by Microsemi. It is the customer's and user's responsibility to independently determine suitability of any Microsemi product and to test and verify the same. The information contained herein is provided "AS IS, WHERE IS" and with all faults, and the entire risk associated with such information is entirely with the User. Microsemi specifically disclaims any liability of any kind including for consequential, incidental and punitive damages as well as lost profit. The product is subject to other terms and conditions which can be located on the web at http://www.microsemi.com/terms-a-conditions.

## **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Microchip: APT45GR65B2DU30